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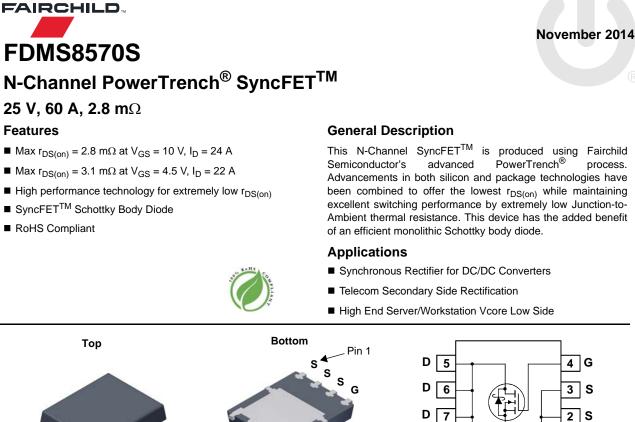


# **ON Semiconductor**®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

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Power 56

D D

## MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			25	V	
V <sub>GS</sub>	Gate to Source Voltage			12	V	
ID	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		60		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	24	Α	
	-Pulsed			100		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	45	mJ	
P <sub>D</sub>	Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			48	W	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

## **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	T <sub>C</sub> = 25 °C	2.6	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a	50	C/vv

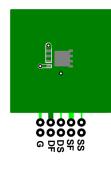
## **Package Marking and Ordering Information**

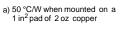
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
10OD	FDMS8570S	Power 56	13"	12 mm	3000 units

1 S

8 D

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	octeristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0 V	25			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		23		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 20 V, V_{GS} = 0 V$			500	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current				±100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.1	1.5	2.2	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$ , referenced to 25 °C		-3		mV/°C	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 24 A		2.1	2.8		
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 22 \text{ A}$		2.4	3.1	mΩ	
		$V_{GS}$ = 10 V, I <sub>D</sub> = 24 A, T <sub>J</sub> = 125 °C		2.9	3.9		
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 24 A$		215		S	
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance			2825		pF	
C <sub>oss</sub>	Output Capacitance	─V <sub>DS</sub> = 13 V, V <sub>GS</sub> = 0 V, f = 1 MHz		662		pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			94		pF	
Rg	Gate Resistance			0.8		Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			11		ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 13 V, I <sub>D</sub> = 24 A,		4		ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		33		ns	
t <sub>f</sub>	Fall Time			3		ns	
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		42		nC	
Q <sub>q</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$ $V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 13 V$ ,		22		nC	
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 24 A		6.4		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			4.4		nC	
Drain-Sou	urce Diode Characteristics						
		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.6	0.8		
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 24 A$ (Note 2)		0.8	1.2	V	
t <sub>rr</sub>	Reverse Recovery Time	—I <sub>F</sub> = 24 A, di/dt = 300 A/μs		22		ns	
Q <sub>rr</sub>	Reverse Recovery Charge	$F = 24 \text{ A}, \text{ u/ul} = 300 \text{ A/}\mu\text{S}$		19		nC	





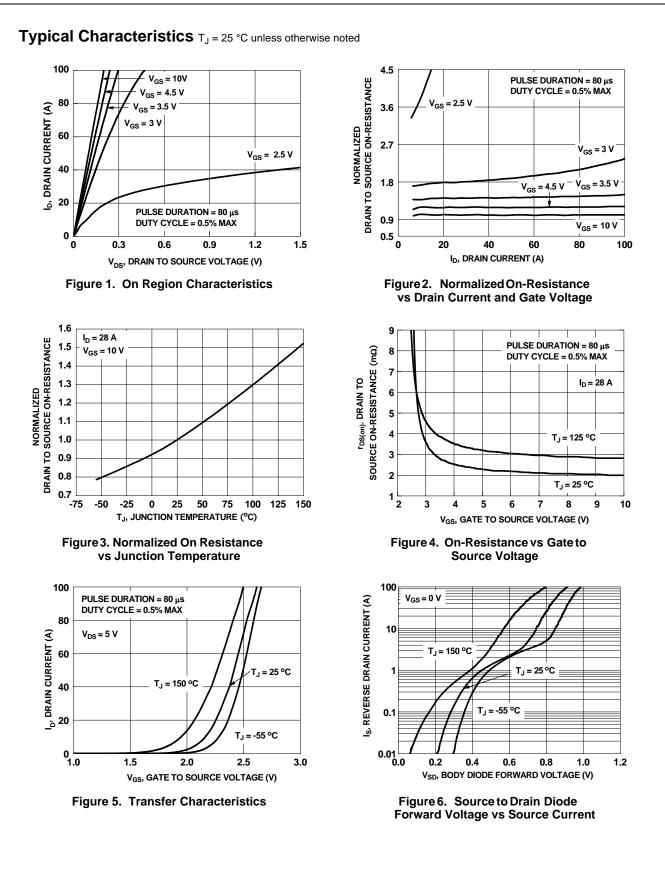


b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

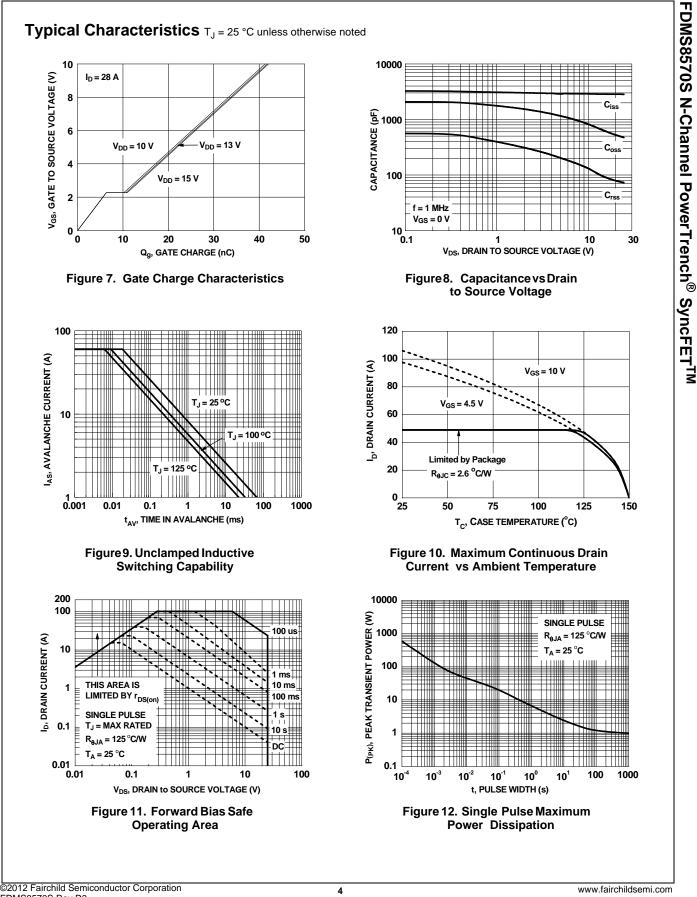
2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%. 3. E<sub>AS</sub> of 45 mJ is based on starting T<sub>J</sub> = 25 °C, L = 0.4 mH, I<sub>AS</sub> = 15 A, V<sub>DD</sub> = 23 V, V<sub>GS</sub> = 10 V. 100% test at L = 0.1 mH, I<sub>AS</sub> = 23.8 A.

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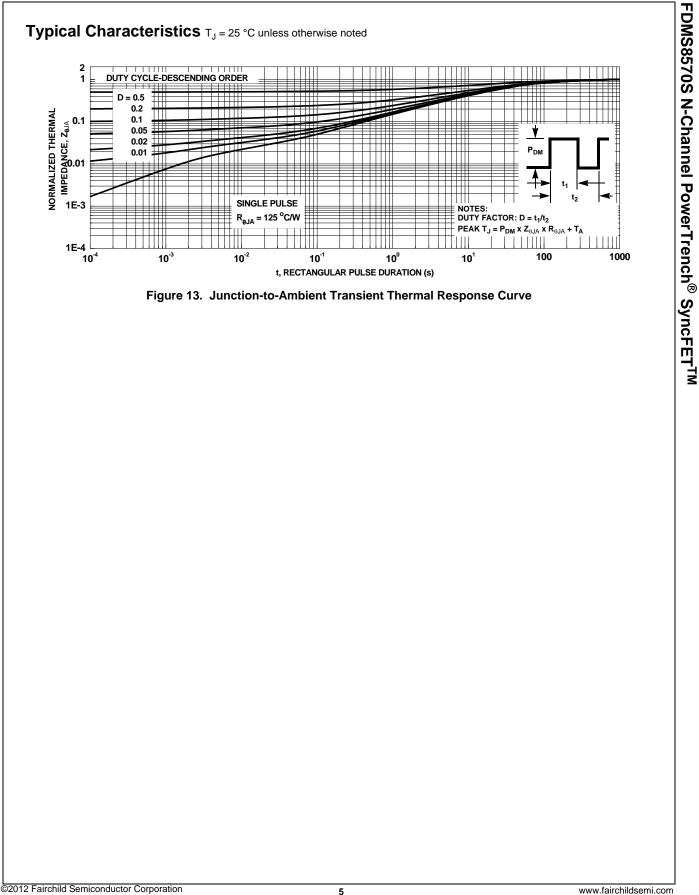
FDMS8570S N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup>



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FDMS8570S Rev.D3



FDMS8570S Rev.D3

# FDMS8570S N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup>

## Typical Characteristics (continued)

## SyncFET<sup>™</sup> Schottky body diode Characteristics

30

25

20

15

10 5

0

-5

0

50

CURRENT (A)

Fairchild's SyncFET<sup>TM</sup> process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverse recovery characteristic of the FDMS8570S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

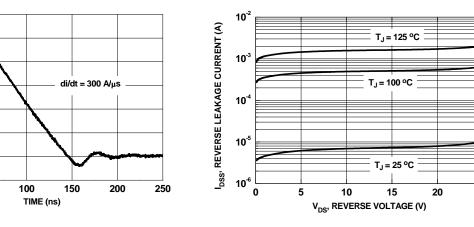


Figure 14. FDMS8570S SyncFET<sup>TM</sup> body diode reverse recovery characteristic

# Figure 15. SyncFET<sup>TM</sup> body diode reverse leakage versus drain-source voltage

25



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